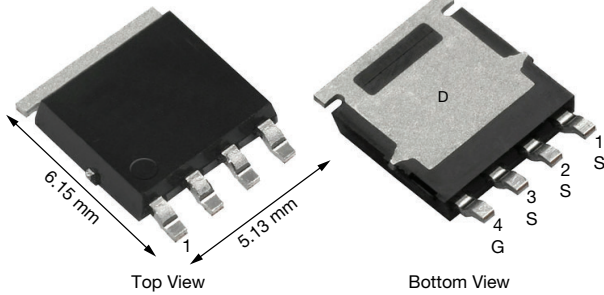


# N-Channel 100 V (D-S) MOSFET

**PowerPAK® SO-8L Single**

**FEATURES**

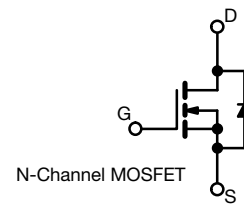
- TrenchFET® Gen IV power MOSFET
- Very low  $Q_g$  and  $Q_{oss}$  reduce power loss and improve efficiency
- Flexible leads provide resilience to mechanical stress
- 100 %  $R_g$  and UIS tested
- $Q_{gd}/Q_{gs}$  ratio < 1 optimizes switching characteristics
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

PRODUCT SUMMARY	
$V_{DS}$ (V)	100
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10$ V	0.009
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5$ V	0.0106
$Q_g$ typ. (nC)	26.5
$I_D$ (A) <sup>a</sup>	56.7
Configuration	Single

**APPLICATIONS**

- Synchronous rectification
- High power density DC/DC
- DC/AC inverters
- Boost converter
- LED backlighting



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SiJ4108DP-T1-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	$V_{DS}$	100	V
Gate-source voltage	$V_{GS}$	$\pm 20$	
Continuous drain current ( $T_J = 150$ °C)	$T_C = 25$ °C	56.7	A
	$T_C = 70$ °C	45.3	
	$T_A = 25$ °C	15.2 <sup>b, c</sup>	
	$T_A = 70$ °C	12.1 <sup>b, c</sup>	
Pulsed drain current ( $t = 100$ $\mu$ s)	$I_{DM}$	150	
Continuous source-drain diode current	$T_C = 25$ °C	63.1	
	$T_A = 25$ °C	4.5 <sup>b, c</sup>	
Single pulse avalanche current	$I_{AS}$	25	
Single pulse avalanche energy	$E_{AS}$	31.25	mJ
Maximum power dissipation	$T_C = 25$ °C	69.4	W
	$T_C = 70$ °C	44	
	$T_A = 25$ °C	5 <sup>b, c</sup>	
	$T_A = 70$ °C	3.2 <sup>b, c</sup>	
Operating junction and storage temperature range	$T_J, T_{stg}$	-55 to +150	°C
Soldering recommendations (peak temperature) <sup>d, e</sup>		260	

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b, f</sup>	$R_{thJA}$	20	25	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	1.3	1.8	

**Notes**

- $T_C = 25$  °C
- Surface mounted on 1" x 1" FR4 board
- $t = 10$  s
- See solder profile ([www.vishay.com/doc?73257](http://www.vishay.com/doc?73257)). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 65 °C/W



SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	100	-	-	V
V <sub>DS</sub> temperature coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	I <sub>D</sub> = 1 mA	-	63	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	I <sub>D</sub> = 250 μA	-	-7.3	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V	-	-	1	μA
		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 75 °C	-	-	15	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.0075	0.009	Ω
		V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 10 A	-	0.0085	0.0106	
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	-	70	-	S
<b>Dynamic <sup>b</sup></b>						
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	2440	-	pF
Output capacitance	C <sub>oss</sub>		-	255	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	16.2	-	
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	34.5	52	nC
		V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 15 A	-	26.5	40	
Gate-source charge	Q <sub>gs</sub>		-	12	-	
Gate-drain charge	Q <sub>gd</sub>		-	5.3	-	
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V	-	46	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.3	0.8	1.4	Ω
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 50 V, R <sub>L</sub> = 3.33 Ω I <sub>D</sub> ≅ 15 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 1 Ω	-	15	30	ns
Rise time	t <sub>r</sub>		-	7	14	
Turn-off delay time	t <sub>d(off)</sub>		-	25	50	
Fall time	t <sub>f</sub>		-	6	12	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 50 V, R <sub>L</sub> = 3.33 Ω I <sub>D</sub> ≅ 15 A, V <sub>GEN</sub> = 7.5 V, R <sub>g</sub> = 1 Ω	-	18	36	
Rise time	t <sub>r</sub>		-	8	16	
Turn-off delay time	t <sub>d(off)</sub>		-	22	44	
Fall time	t <sub>f</sub>		-	7	14	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	63.1	A
Pulse diode forward current (t <sub>p</sub> = 100 μs)	I <sub>SM</sub>		-	-	150	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A	-	0.75	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C	-	42	84	ns
Body diode reverse recovery charge	Q <sub>rr</sub>		-	55	110	nC
Reverse recovery fall time	t <sub>a</sub>		-	26	-	ns
Reverse recovery rise time	t <sub>b</sub>		-	16	-	

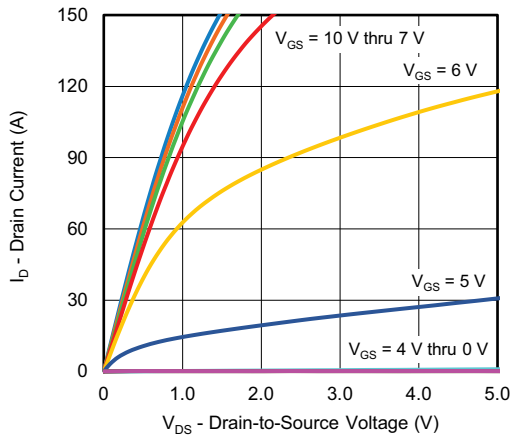
**Notes**

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- b. Guaranteed by design, not subject to production testing

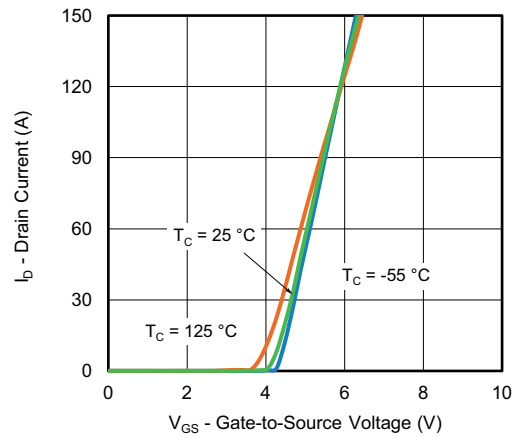
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



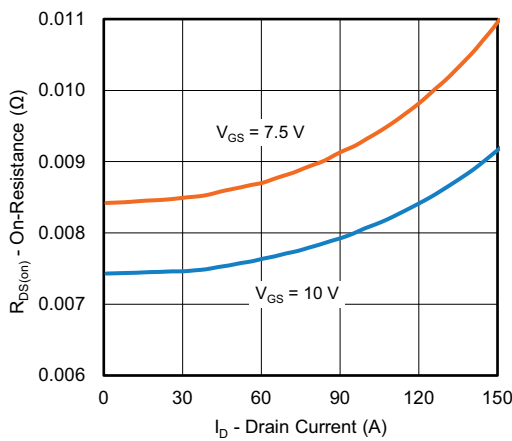
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



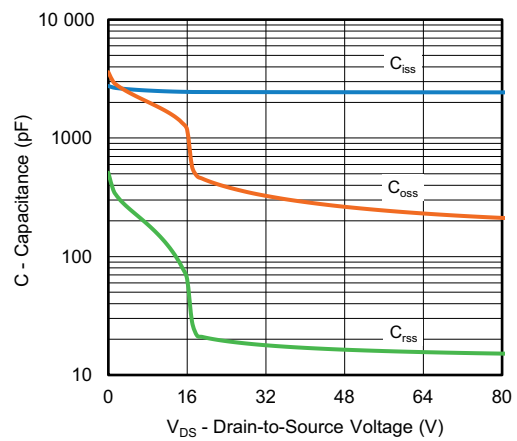
**Output Characteristics**



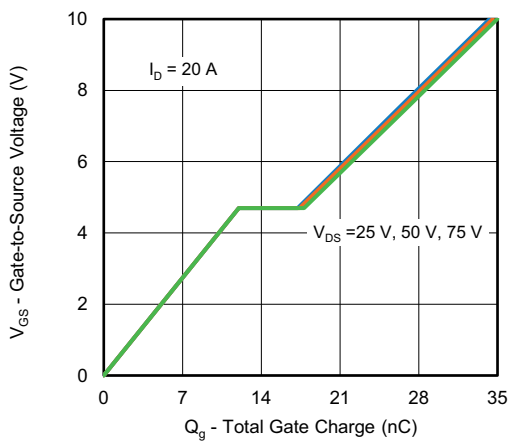
**Transfer Characteristics**



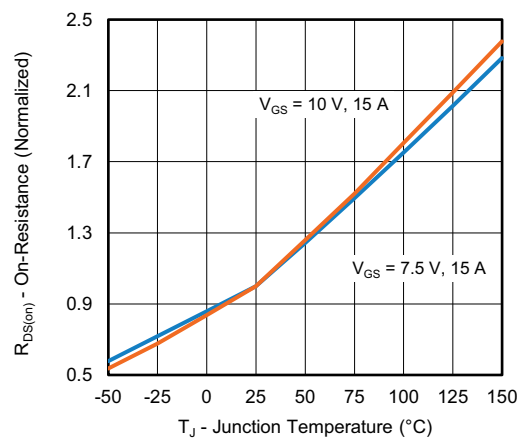
**On-Resistance vs. Drain Current**



**Capacitance**



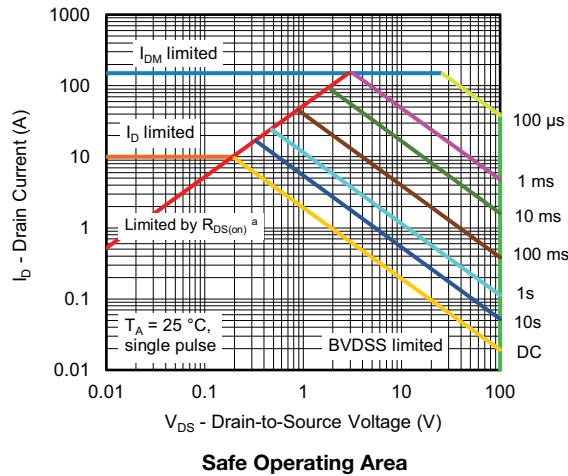
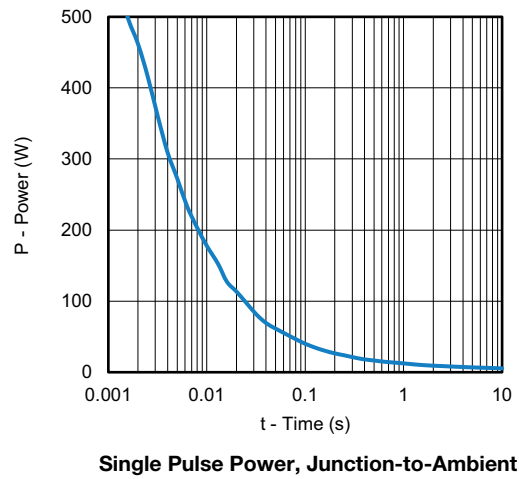
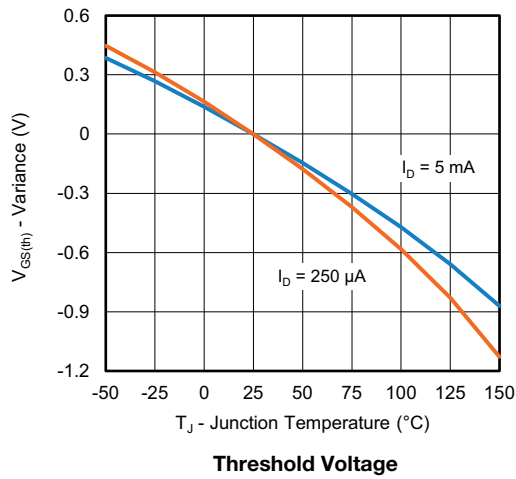
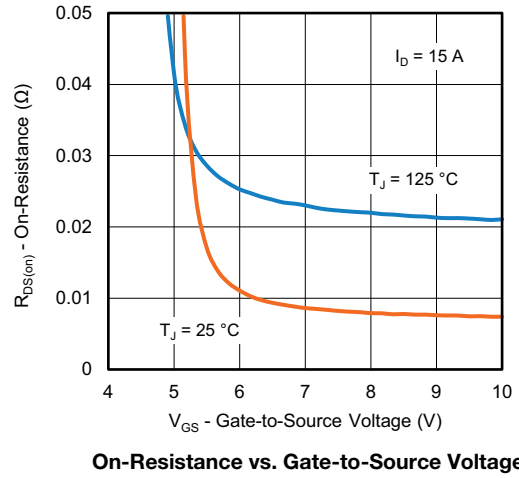
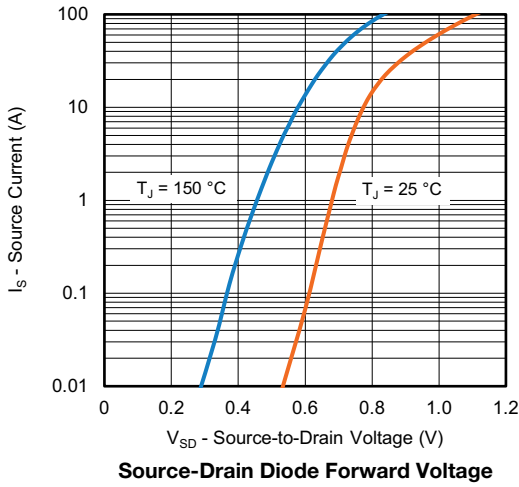
**Gate Charge**



**On-Resistance vs. Junction Temperature**



**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

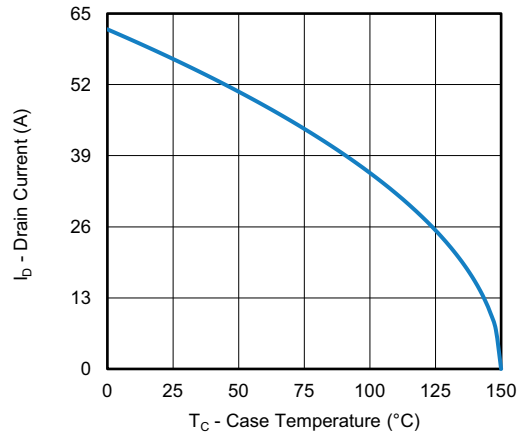


**Note**

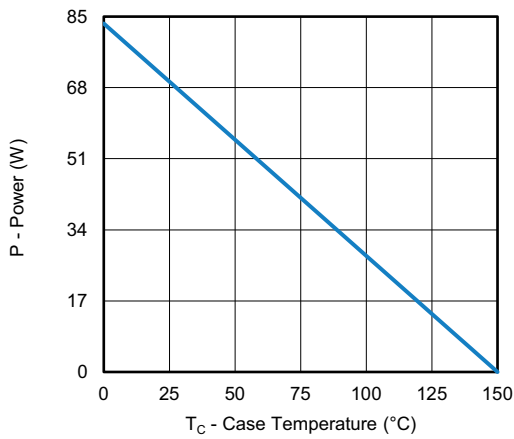
a.  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



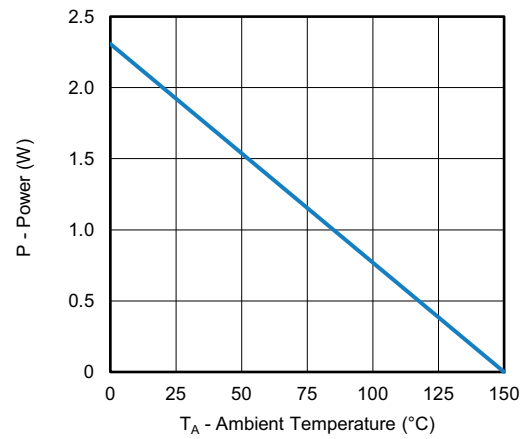
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



**Current Derating <sup>a</sup>**



**Power, Junction-to-Case**



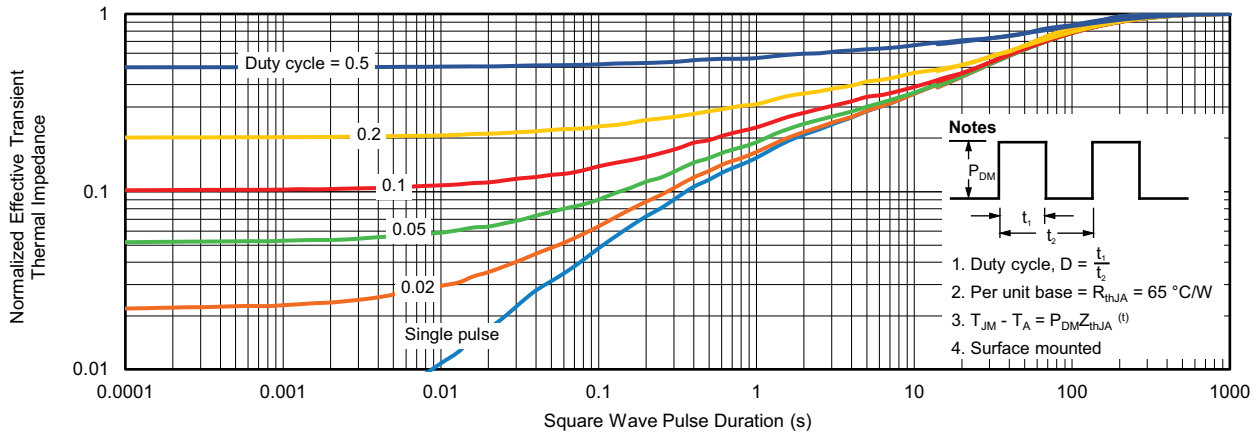
**Power, Junction-to-Ambient**

**Note**

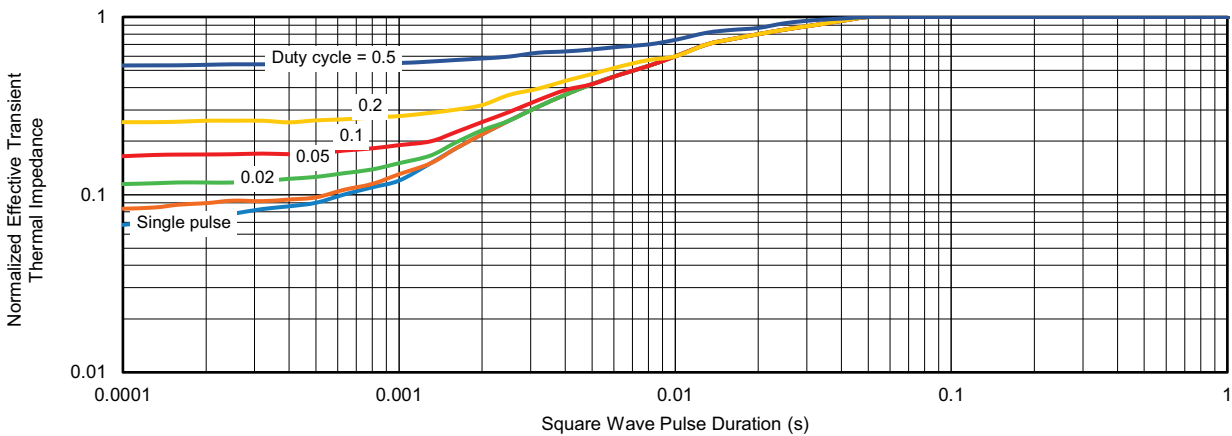
- a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Case**

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